

Ultra Precision Reference

FEATURES

- 1.2µV_{P-P} Noise
- 2µV/√kHr Long-Term Stability
- Very Low Hysteresis
- 0.05ppm/°C Drift
- Temperature Stabilized
- 400°C/W Thermal Resistance for LTZ1000A Reduces Insulation Requirements
- Specified for –55°C to 125°C Temperature Range
- Offered in TO-99 package

APPLICATIONS

- Voltmeters
- Calibrators
- Standard Cells
- Scales
- Low Noise RF Oscillators

DESCRIPTION

The LTZ1000 and LTZ1000A are ultra-stable temperature controllable references. They are designed to provide 7V outputs with temperature drifts of 0.05ppm/°C, about $1.2\mu V_{P-P}$ of noise and long-term stability of $2\mu V/\sqrt{kHr}$.

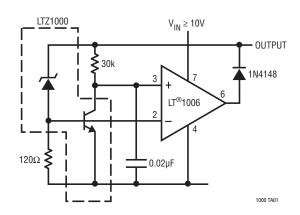
Included on the chip is a subsurface zener reference, a heater resistor for temperature stabilization, and a temperature sensing transistor. External circuitry is used to set operating currents and to temperature stabilize the reference. This allows maximum flexibility and best long-term stability and noise.

The LTZ1000 and LTZ1000A references can provide superior performance to older devices such as the LM199, provided that the user implements the heater control and properly manages the thermal layout. To simplify thermal insulation, the LTZ1000A uses a proprietary die attach method to provide significantly higher thermal resistance than the LTZ1000.

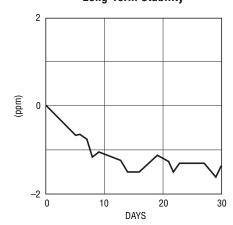
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TYPICAL APPLICATION

Low Noise Reference



Long-Term Stability



LONG-TERM STABILITY OF A TYPICAL DEVICE FROM TIME = 0 WITH NO PRECONDITIONING OR AGING

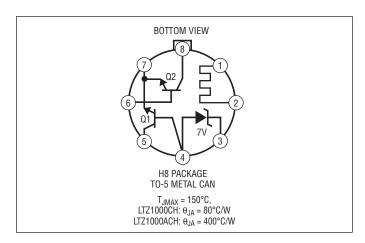
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ABSOLUTE MAXIMUM RATINGS

(Note 1)

Heater to Substrate	35V
Collector Emitter Breakdown Q1	15V
Collector Emitter Breakdown Q2	35V
Emitter Base Reverse Bias	2V
Operating Temperature Range55°C ≤	$T_A \leq 125^{\circ}C$
Storage Temperature Range65°C ≤	$T_A \le 150$ °C
Substrate Forward Bias	0.1V

PIN CONFIGURATION



ORDER INFORMATION

LEAD FREE FINISH	PART MARKING	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE
LTZ1000ACH#PBF	LTZ1000ACH	8-Lead TO-5 Metal Can (.200 Inch PCD)	–55°C to 125°C
LTZ1000CH#PBF	LTZ1000CH	8-Lead TO-5 Metal Can (.200 Inch PCD)	–55°C to 125°C
LEAD BASED FINISH	PART MARKING	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE
LTZ1000ACH	LTZ1000ACH	8-Lead TO-5 Metal Can (.200 Inch PCD)	-55°C to 125°C
LTZ1000CH	LTZ1000CH	8-Lead TO-5 Metal Can (.200 Inch PCD)	-55°C to 125°C

Consult LTC Marketing for parts specified with wider operating temperature ranges.

For more information on lead free part marking, go to: http://www.linear.com/leadfree/

This product is only offered in trays. For more information go to: http://www.linear.com/packaging/

ELECTRICAL CHARACTERISTICS (Note 2)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
Zener Voltage	$I_Z = 5\text{mA}, (V_Z + VBE_{Q1}) I_{Q1} = 100\mu\text{A}$ $I_Z = 1\text{mA}, (V_Z + VBE_{Q1}) I_{Q1} = 100\mu\text{A}$	7.0 6.9	7.2 7.15	7.5 7.45	V
Zener Change with Current	$1mA \le I_Z < 5mA$		80	240	mV
Zener Leakage Current	V _Z = 5V		20	200	μА
Zener Noise	I _Z = 5mA, 0.1Hz < f < 10Hz 1 _{Q1} = 100μA		1.2	2	μV _{P-P}
Heater Resistance	I _L ≤ 100μA	200	300	420	Ω
Heater Breakdown Voltage		35			V
Transistor Q1 Breakdown	I _C = 10μA, LVCEO	15	20		V
Transistor Q2 Breakdown	I _C = 10μA, LVCEO	35	50		V
Q1, Q2 Current Gain	I _C = 100μA	80	200	450	
Thermal Resistance	LTZ1000 Time = 5 Minutes LTZ1000A Time = 5 Minutes		80 400		°C/W °C/W
Long-Term Stability	T = 65°C		2		μV√kHr

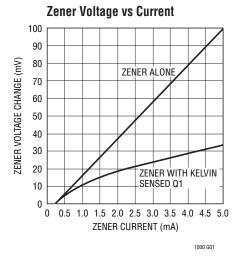
Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

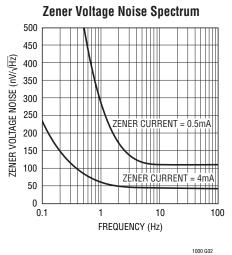
Note 2: All testing is done at 25°C. Pulse testing is used for LTZ1000A to minimize temperature rise during testing. LTZ1000 and LTZ1000A devices are QA tested at -55°C and 125°C.

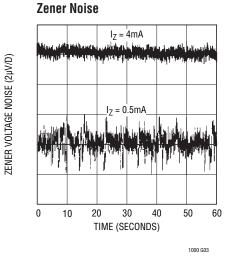
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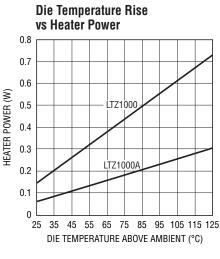


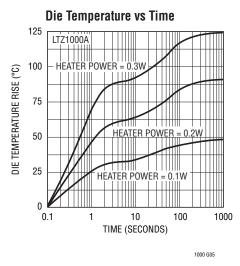
TYPICAL PERFORMANCE CHARACTERISTICS

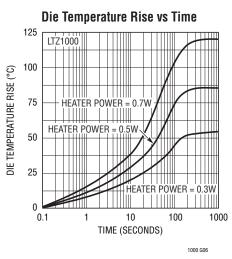












PIN FUNCTIONS

Pin 1: Heater Positive. Must have a higher positive value than Pin 2 and Pin 4.

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Pin 2: Heater Negative. Must have a higher positive value than Pin 4. Must have equal or lower potential than Pin 1.

Pin 3: Zener Positive. Must have a higher positive value than Pin 4.

Pin 4: Substrate and Zener Negative. Must have a higher positive value than Pin 7. If Q1 is zenered (about 7V) a permanent degradation in beta will result.

Pin 5: Temperature Compensating Transistor Collector.

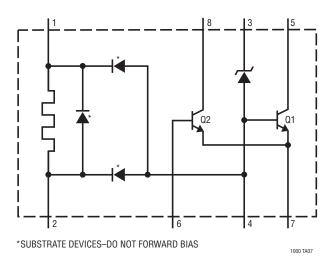
Pin 6: Temperature Sensing Transistor Base. If the base emitter junction is zenered (about 7V) the transistor will suffer permanent beta degradation.

Pin 7: Emitter of Sensing and Compensating Transistors.

Pin 8: Collector of Sensing Transistor.



BLOCK DIAGRAM



APPLICATIONS INFORMATION

LTZ1000 and LTZ1000A are capable of providing ultimate voltage reference performance. Temperature drifts of better than 0.03ppm/°C and long-term stability on the order of $1\mu V$ per month can be achieved. Noise of about 0.15ppm can also be obtained. This performance is at the expense of circuit complexity, since external influences can easily cause output voltage shifts of more than 1ppm.

Thermocouple effects are one of the worst problems and can give apparent drifts of many ppm/°C as well as cause low frequency noise. The kovar input leads of the TO-5 package form thermocouples when connected to copper PC boards. These thermocouples generate outputs of $35\mu V/^{\circ}C$. It is mandatory to keep the zener and transistor leads at the same temperature, otherwise 1ppm to 5ppm shifts in the output voltage can easily be expected from these thermocouples.

Air currents blowing across the leads can also cause small temperature variations, especially since the package is heated. This will look like 1ppm to 5ppm of low frequency noise occurring over a several minute period. For best results, the device should be located in an enclosed area and well shielded from air currents.

Certainly, any temperature gradient externally generated, say from a power supply, should not appear across the critical circuitry. The leads to the transistor and zener

should be connected to equal size PC traces to equalize the heat loss and maintain them at similar temperatures. The bottom portion of the PC board should be shielded against air currents as well.

Resistors, as well as having resistance temperature coefficients, can generate thermocouple effects. Some types of resistors can generate hundreds of microvolts of thermocouple voltage. These thermocouple effects in the resistor can also interfere with the output voltage. Wire wound resistors usually have the lowest thermocouple voltage, while tin oxide type resistors have very high thermocouple voltage. Film resistors, especially Vishay precision film resistors, can have low thermocouple voltage.

Ordinary breadboarding techniques are not good enough to give stable output voltage with the LTZ1000 family devices. For breadboarding, it is suggested that a small printed circuit board be made up using the reference, the amplifier and wire wound resistors. Care must be taken to ensure that heater current does not flow through the same ground lead as the negative side of the reference (emitter of Q1). Current changes in the heater could add to, or subtract from, the reference voltage causing errors with temperature. Single point grounding using low resistance wiring is suggested.

TECHNOLOGY TECHNOLOGY

APPLICATIONS INFORMATION

Setting Control Temperature

The emitter-base voltage of the control transistor sets the stabilization temperature for the LTZ1000. With the values given in the applications, temperature is normally 60°C. This provides 15°C of margin above a maximum ambient of 45°C, for example. Production variations in emitter-base voltage will typically cause about ±10°C variation. Since the emitter-base voltage changes about 2mV/°C and is very predictable, other temperatures are easily set.

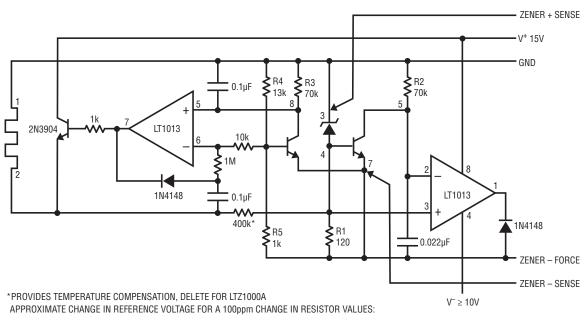
Because higher temperatures accelerate aging and decrease long-term stability, the lowest temperature consistent with the operating environment should be used. The LTZ1000A should be set about 10°C higher than the LTZ1000. This

is because normal operating power dissipation in the LTZ1000A causes a temperature rise of about 10°C. Of course both types of devices should be insulated from ambient. Several minutes of warm-up is usual.

For applications not requiring the extreme precision or the low noise of the LTZ1000, Linear Technology makes a broad line of voltage references. Devices like the LT1021 can provide drifts as low as 2ppm/°C and devices such as the LM399A can provide drifts of 1ppm/°C. Only applications requiring the very low noise or low drift with time of the LTZ1000 should use this device. See Application Notes AN-82 and AN-86 for further information. Consult the Linear Technology Applications department for additional help.

TYPICAL APPLICATIONS

Negative Voltage Reference



 $\begin{array}{ccc} & 100 \text{ppm} = \Delta R(\Omega) & \Delta V_Z \\ \text{R1} & 0.012 \Omega & 1 \text{ppm} \\ \text{R2} & 7 \Omega & 0.3 \text{ppm} \\ \text{R3} & 7 \Omega & 0.2 \text{ppm} \\ \text{R4/R5 RATIO} & \Delta R = 0.01\% & 1 \text{ppm} \\ \end{array}$

BOTH A1 AND A2 CONTRIBUTE LESS THAN 2μV OF OUTPUT DRIFT OVER A 50°C RANGE

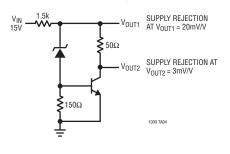
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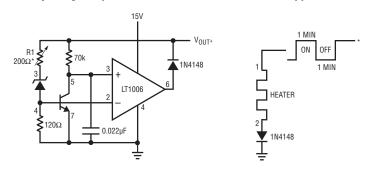
TYPICAL APPLICATIONS

Averaging Reference Voltage for Lower Noise and Better Stability

Improving Supply Rejection

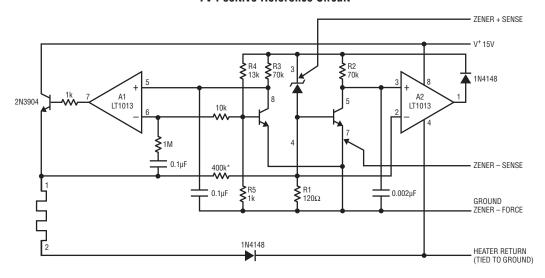


Adjusting Temperature Coefficient in Unstabilized Applications



* PULSE HEATER ON AND OFF TO HEAT AND COOL THE REFERENCE. ADJUST R1 FOR MINIMUM VOLTAGE CHANGE THROUGH A TEMPERATURE CYCLE. THE –2mV/°C TEMPCO OF THE V_{BE} CANCELS THE +2mV/°C TEMPCO OF THE ZENER.

7V Positive Reference Circuit



*PROVIDES TC COMPENSATION, DELETE FOR LTZ1000A APPROXIMATE CHANGE IN REFERENCE VOLTAGE FOR A 100ppm (0.01%) CHANGE IN RESISTOR VALUES:

BOTH A1 AND A2 CONTRIBUTE LESS THAN $2\mu V$ OF OUTPUT DRIFT OVER A 50°C RANGE

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LINEAD

REVISION HISTORY (Revision history begins at Rev D)

REV	DATE	DESCRIPTION	PAGE NUMBER
D	4/12	Corrected thermal information on H8 package drawing	2
		Corrected Order Information table	2
		Updated Block Diagram to show substrate diode	4
		Added 1N4148 label to diode in application circuit	5
		Added LTC6655 to Related Parts table	8

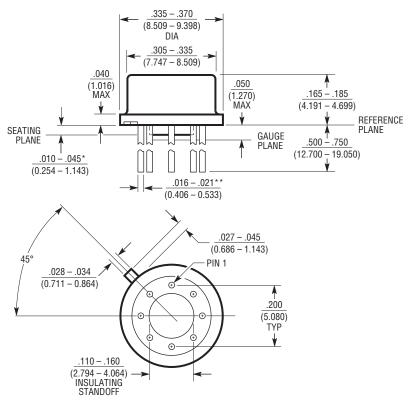


PACKAGE DESCRIPTION

Please refer to http://www.linear.com/designtools/packaging/ for the most recent package drawings.

H Package 8-Lead TO-5 Metal Can (.200 Inch PCD)

(Reference LTC DWG # 05-08-1320)



^{*}LEAD DIAMETER IS UNCONTROLLED BETWEEN THE REFERENCE PLANE AND THE SEATING PLANE

RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LM399	7V Precision Shunt Reference	0.2% Accuracy, 0.5ppm/°C Drift, 20μV _{RMS} Noise
LT1021	5V, 7V and 10V Precision Reference	Available in T0-5, -55°C to 125°C, Series or Shunt Operation
LT1236	5V and 10V Low Drift Precision Reference	0.05% Accuracy, 5ppm/°C Drift, Series or Shunt Operation
LT1389	1.25V, 2.5V, 4V and 5V Nanopower Shunt Reference	800nA, 0.05% Accuracy, 10ppm/°C Drift
LT1634	1.25V and 2.5V Micropower Shunt Reference	0.05%, 10ppm/°C, 10µA Current
LTC6655	Precision Low Noise Reference Family	2ppm/°C, Maximum Drift, 650nV _{P-P} Noise (0.1Hz to 10Hz)

^{**}FOR SOLDER DIP LEAD FINISH, LEAD DIAMETER IS $\frac{.016 - .024}{(0.406 - 0.610)}$ H8(TO-5) 0.200 PCD 0204